

GAP-145F-S7 Series 1U RUGGED SERVER

3rd Gen Intel® Xeon® Scalable Processors
Front I/O - Rear Power Supply



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Computer

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GAP is a family of rugged servers and workstations with an aluminum construction, designed for applications that require robust and qualified MIL-GRADE equipment, suitable for operations in critical environments.

GAP-145F-S7 rugged servers feature dual socket 3rd Gen Intel® Xeon® Scalable Processors (Ice Lake), a balanced architecture that delivers built-in AI acceleration and advanced security capabilities, up to 4TB DDR4-3200 RAM, 64 lane PCIe Gen 4 and +7% higher socket-to-socket bandwidth. The integrated IPMI services support monitoring, control, and management functions sending alarm notifications in case of critical events.

GAP-145F-S7 are designed for 19" rackmounting and have a 1U chassis with a depth of 450mm.

The front I/O and rear power supply layout includes dual internal M.2 NVMe socket and a 3.5" drive bay that can host up to two removable U.2 NVMe SSD or up to three removable 2.5" SAS/ SATA SSD.

GAP-145F-S7 rugged servers host up to two OCP 3.0 compliant NIC cards with PCIe 4.0 bandwidth and a tool-less, hot-swappable design, supporting GbE / 10GbE / 25GbE / 100GbE in RJ45 or SFP version. Furthermore it can accommodate two PCIe cards.

Additional boards can be provided with a dedicated retainer kit for an optimal protection against shocks and vibrations also during transport.

GAP servers are designed to meet MIL-STD-810F for temperature and shocks, MIL-STD-167-1A for vibrations. Optionally, they can conform to MIL-STD-461 for EMI/EMC. The I/O connectors and the power supply input can be provided with MIL-GRADE connectors upon request.

All units are delivered with their inventory list to ensure configuration control and reproducibility over time. Upon request, all server configurations can run specific thermal or mechanical environmental stress test.

FEATURES

- 1U Rugged Server - 450mm depth
- Dual Socket Motherboard
- 3rd Gen Intel® Xeon® Scalable Processors
- Front I/O connectors and rear Power Input
- Single AC or DC Power Supply
- Removable Fans
- 2 x U.2 NVMe or 3 x 2.5" SATA/SAS SSD
- Up to 2 PCIe boards + 2 x OCP NIC 3.0
- Optional Conformal Coating
- MIL-STD-810G
- Optional MIL-STD-461

Technical Specifications

System

CPU	3 rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) max 205W TDP
Memory	Up to 4TB ECC RDIMM, DDR4-3200MHz; 16 DIMM slots
Chipset	Intel® C621A
Graphics	ASPEED AST2600 BMC
Network Connectivity	1x Dedicated IPMI LAN port Up to 2x Dual or Quad port GbE/10GbE/25GbE/100GbE OCP NIC 3.0 with RJ45 or SFP connectors
Storage	Internal: 2x M.2 NVMe; M-Key, 2280 1x Disk on Module Removable: Up to 2x U.2 NVMe SSD or up to 3x 2.5" SATA / SAS SSD
TPM	1x TPM Header
Motherboard I/O shield	Available on the front: 1x VGA, 2x USB 3.0, 1x IPMI LAN; 1x COM
Expansion slots	2x PCIe 4.0 x16 FHHL
Operative Systems	Windows® 10 IoT Enterprise 64bit, Windows® Server 2016 64bit; Windows® Server 2019 64bit; RHEL 8.4 64bit; Ubuntu 20.04.2 LTS SVR 64bit; CentOS 7.9 64bit
IPMI	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications
Remote Monitoring	Monitoring, control, and management functions (fan speed, temperature, voltage, redundant power failure, power consumption, disk health, raid health, and memory health)

Power Supply

Power Supply	AC Single Power Supply DC Single Power Supply
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Mechanical

Dimensions	483 x 44 x 450 mm (W x H x D)
Material	Aluminum with surface passivation treatment
Colour	Black / RAL 9005 - Powder Coating
Mounting	1U 19" rackmount chassis Optional Telescopic slides
Configuration	Front I/O - Rear Power Supply
Front Panel Leds / Buttons	Power On/Off button with LED Reset button with LED
Drive Bays	3x 3.5" + 1x 2.5" internal bay
Fans	6x removable PWM fans

Environmental - (Design to meet)

Operating Temperatures	0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)
Storage Temperature	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7
Humidity	5% – 95% non-condensing MIL-STD-810H 507.6
Operating Vibrations	MIL-STD-167-1A, Type I
Not Operating Vibrations	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8
Operating Shocks	20g / 11ms – half sine MIL-STD-810G, Method 516.7
EMC	Directive 2014/35/UE-LVD Directive 2014/30/UE-EMC Directive 2011/65/UE - RoHS Regulation EC No 1907/2006 MIL-STD-461G (on request)

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.